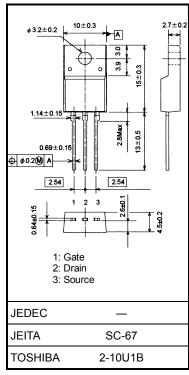
TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSIV)

2SK3565

Switching Regulator Applications

- Low drain-source ON resistance: R_{DS (ON)} = 2.0 Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 4.5 \text{ S}$ (typ.)
- Low leakage current: I_{DSS} = 100 μ A (V_{DS} = 720 V)
- Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C) Symbol Unit Characteristics Rating Drain-source voltage 900 ٧ VDSS 900 v Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$) VDGR Gate-source voltage ± 30 V VGSS DC 5 (Note 1) I_D Drain current А Pulse (t = 1 ms) 15 IDP (Note 1) Drain power dissipation (Tc = 25°C) 45 W P_D Single pulse avalanche energy 595 mJ E_{AS} (Note 2) 5 Avalanche current А I_{AR} 4.5 Repetitive avalanche energy (Note 3) mJ EAR °C Channel temperature T_{ch} 150 °C Storage temperature range -55~150 Tstg



Weight : 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

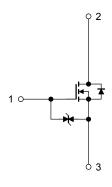
Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to case	R _{th (ch-c)}	2.78	°C/W	
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 90 \text{ V}, \text{ T}_{ch} = 25^{\circ}C(\text{Initial}), \text{ L} = 43.6 \text{ mH}, \text{ I}_{AR} = 5.0 \text{ A}, \text{ R}_{G} = 25 \Omega$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



Unit: mm

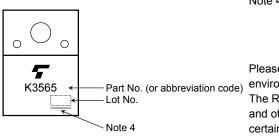
Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS}=\pm 25~V,~V_{DS}=0~V$			±10	μA
Gate-source brea	akdown voltage	V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30			V
Drain cut-off curre	ent	I _{DSS}	$V_{DS} = 720 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			100	μA
Drain-source brea	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	900			V
Gate threshold vo	oltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	2.0		4.0	V
Drain-source ON	resistance	R _{DS (ON)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		2.0	2.5	Ω
Forward transfer	admittance	Y _{fs}	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 3 \text{ A}$	2.0	4.5	_	S
Input capacitance	e	C _{iss}			1150		
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		20		pF
Output capacitance		C _{oss}			100	_	
Switching time	Rise time	tr	V_{GS} $0 V$ $I_D = 3 A V_{OUT}$ V_{GS} $0 V$ $F_L = 66.7 \Omega$ $V_{DD} \simeq 200 V$		30		ns
	Turn-on time	t _{on}			70	_	
	Fall time	tf			60		
	Turn-off time	t _{off}	Duty \leq 1%, $t_W =$ 10 μs		170	_	
Total gate charge Qg		Qg		_	28	_	
Gate-source charge		Qgs	$V_{DD} \simeq 400 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	_	17	_	nC
Gate-drain charge		Q _{gd}]	_	11	—	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_		5	А
Pulse drain reverse current (Note 1)	I _{DRP}	—	_	_	15	А
Forward voltage (diode)	V _{DSF}	$I_{DR} = 5 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	_	_	-1.7	V
Reverse recovery time	t _{rr}	$I_{DR} = 5 \text{ A}, V_{GS} = 0 \text{ V},$	_	900	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 100 A/µs	_	5.4	_	μC

Marking

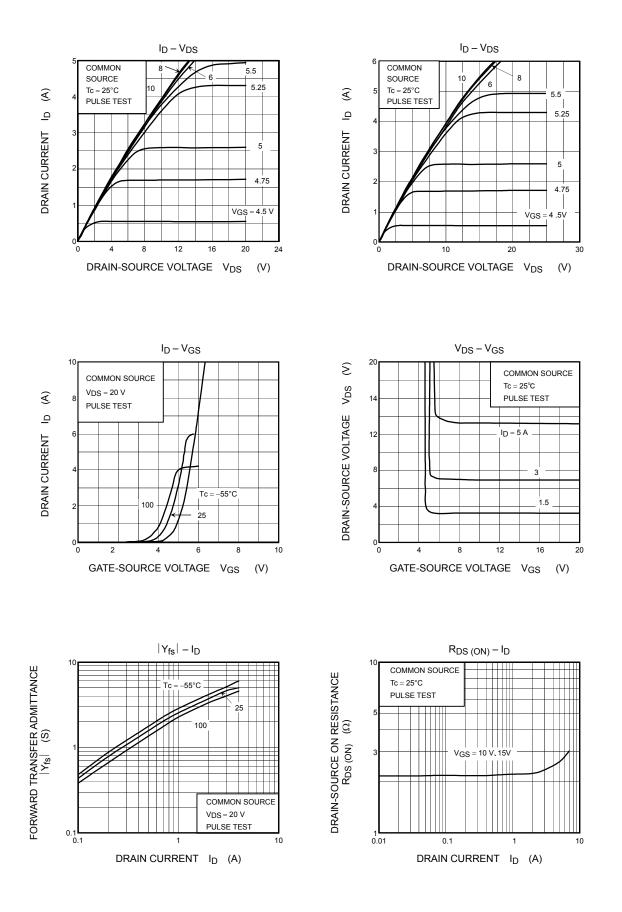


Note 4: A line under a Lot No. identifies the indication of product Labels.

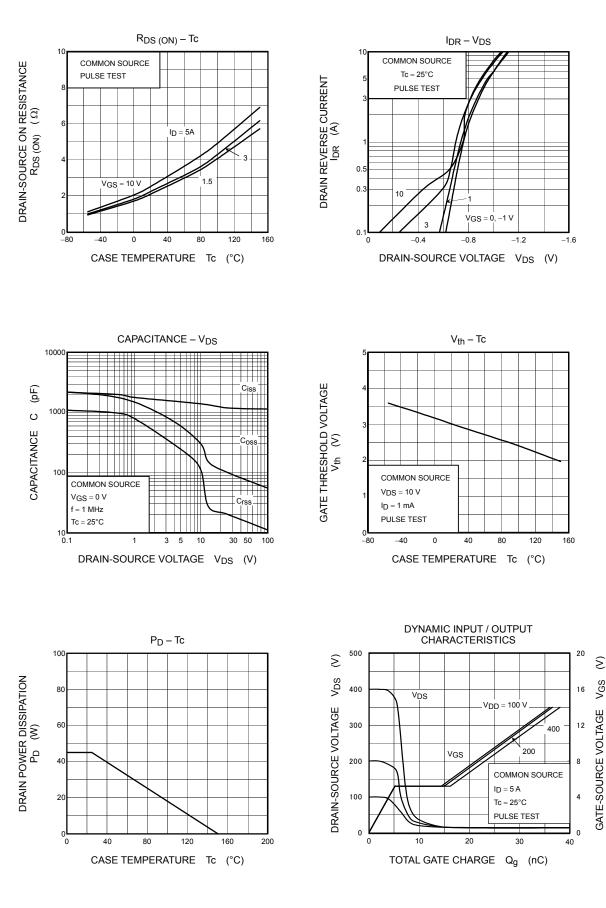
Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

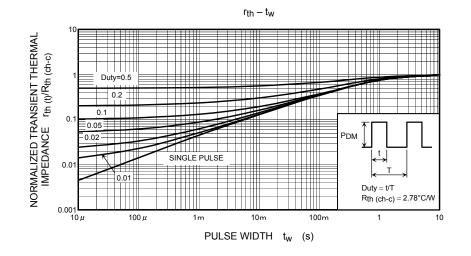
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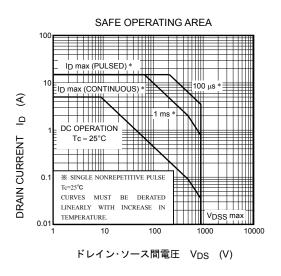
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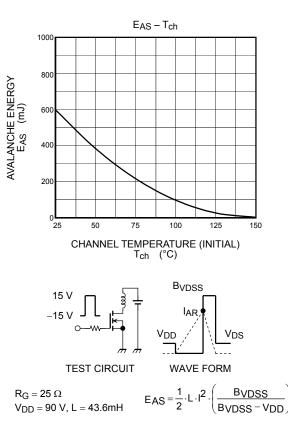


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